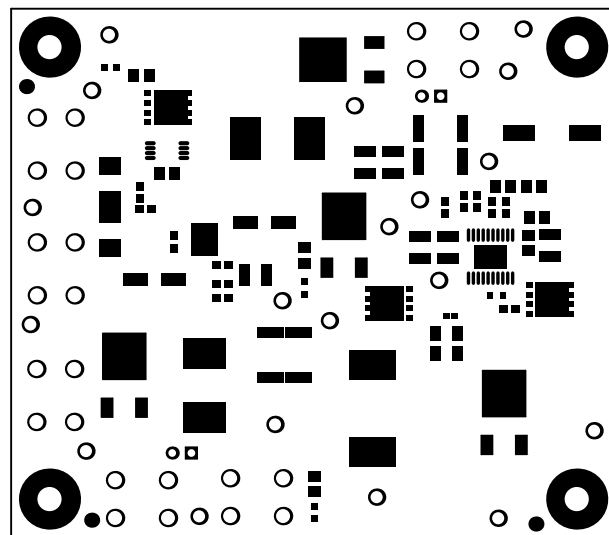
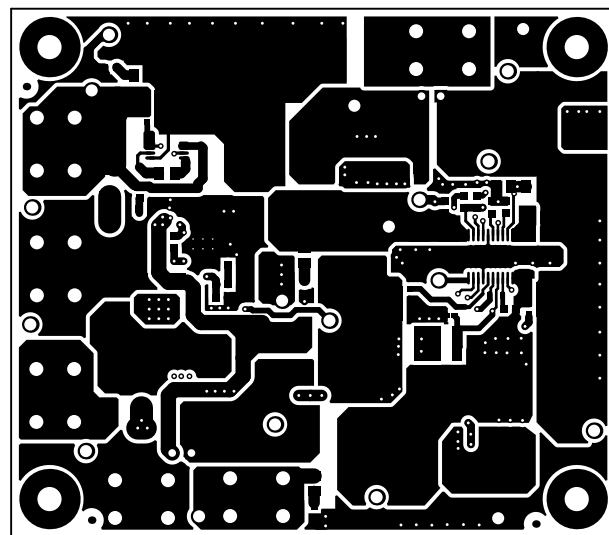


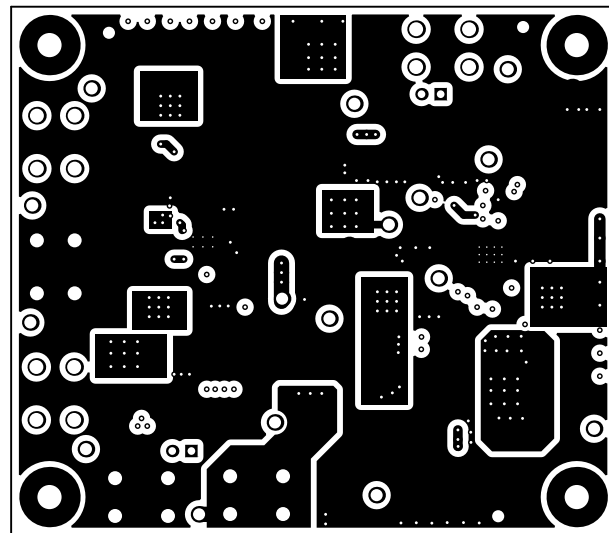
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01179	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: 01179		
PLOT NAME = Top Overlay	GENERATED : 8/12/2016 10:27:04 AM	TEXAS INSTRUMENTS	



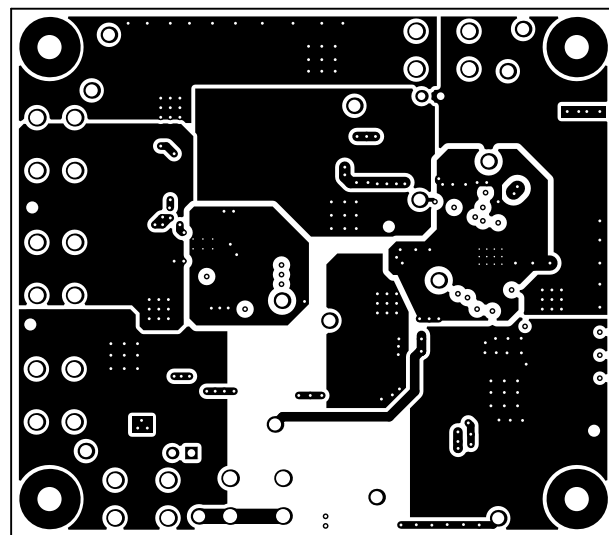
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01179	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: 01179		
PLOT NAME = Top Solder Mask	GENERATED : 8/12/2016 10:27:07 AM	TEXAS INSTRUMENTS	



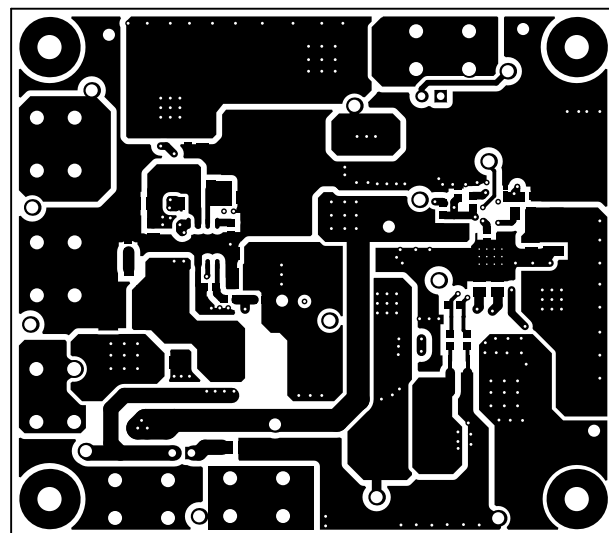
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01179	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: 01179		
PLOT NAME = Top Layer	GENERATED : 8/12/2016 10:27:09 AM	TEXAS INSTRUMENTS	



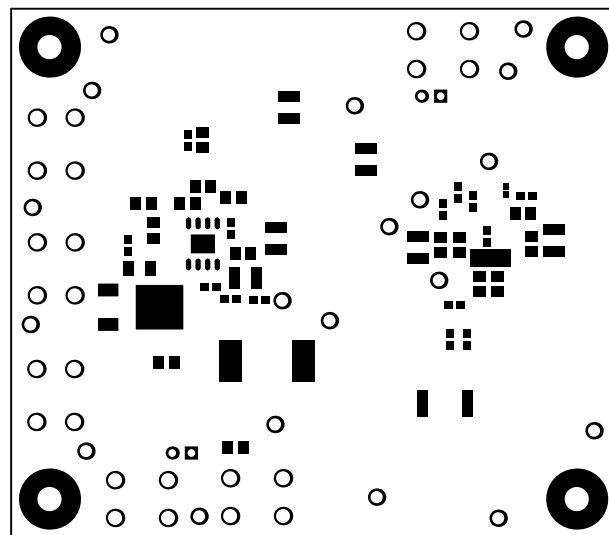
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01179	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = 2nd Layer	TID #: 01179		
PLOT NAME = Signal Layer 1	GENERATED : 8/12/2016 10:27:11 AM	TEXAS INSTRUMENTS	



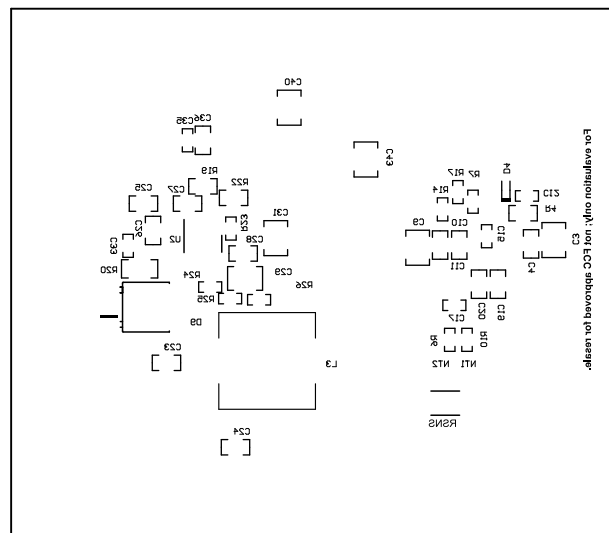
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01179	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = 3rd layer	TID #: 01179		
PLOT NAME = Signal Layer 2	GENERATED : 8/12/2016 10:27:13 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01179	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: 01179		
PLOT NAME = Bottom Layer	GENERATED : 8/12/2016 10:27:15 AM	TEXAS INSTRUMENTS	

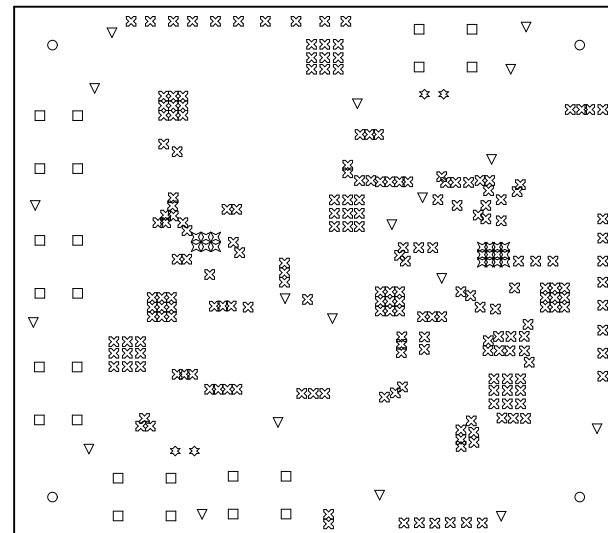


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01179	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: 01179		
PLOT NAME = Bottom Solder Mask	GENERATED : 8/12/2016 10:27:17 AM	TEXAS INSTRUMENTS	

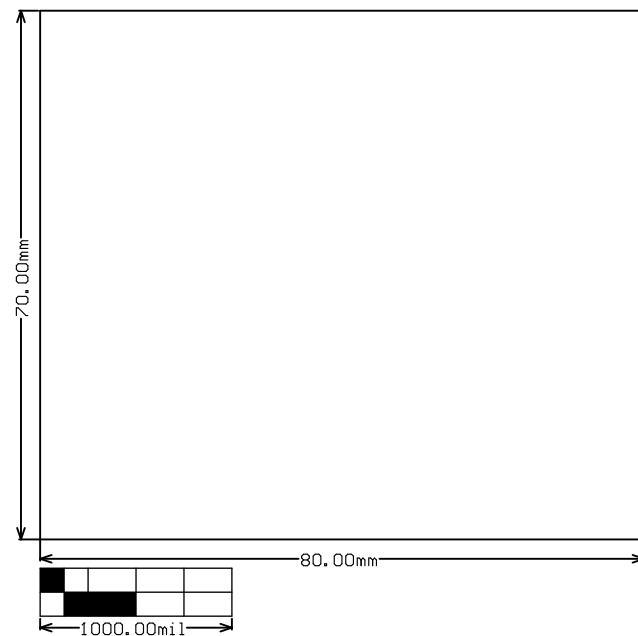


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01179	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: 01179		
PLOT NAME = Bottom Overlay	GENERATED : 8/12/2016 10:27:19 AM	TEXAS INSTRUMENTS	

Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Drill Layer Pair	Hole Tolerance
✕	18	0.200mm (7.87mil)	PTH	Round	Top Layer - Bottom Layer	
⊗	210	0.381mm (15.00mil)	PTH	Round	Top Layer - Bottom Layer	
☆	4	1.016mm (40.00mil)	PTH	Round	Top Layer - Bottom Layer	
▽	19	1.600mm (63.00mil)	PTH	Round	Top Layer - Bottom Layer	
□	24	1.850mm (72.83mil)	PTH	Round	Top Layer - Bottom Layer	
○	4	3.200mm (125.98mil)	PTH	Round	Top Layer - Bottom Layer	
	279 Total					



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01179	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: 01179		
PLOT NAME = Drill Drawing	GENERATED : 8/12/2016 10:27:21 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01179	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: 01179		
PLOT NAME = Board Dimensions	GENERATED : 8/12/2016 10:27:23 AM	TEXAS INSTRUMENTS	

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